



Photonics Packages

General Information:

- 1: Wide selection of package style in Ceramic Eyelet configuration, Glass Eyelet configuration, Multiple-layer HTCC configuration with the options of GPO, Window-lens integration
- 2: Manufacturing Standard: China Military Standard GJB923A-2004 , GJB548 or similar to MIL-STD 883/MIL-PRF-38354

Typical Packages:

1. Butterfly package with Ceramic Eyelet, HTCC Feedthrough, with GPO/Window-lens
2. HHL Package with Ceramic Eyelet, TO220 Packages, Full Copper 9mm Header
3. XMD TOSA 8, 9pin packages
4. TO header with glass Eyelet
5. Ceramic Eyelet Package for high power diode

